

SBT – Socket for Burn-in and Test Applications

High Performance
IC Sockets And
Test Adaptors



Application Need

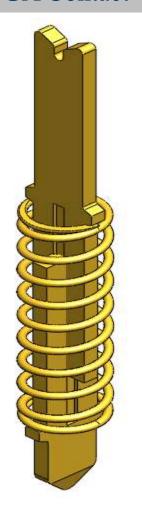
Custom Burn-in and Standard Production Test Applications usually demand a spring probe solution

- Custom Burn-in sockets are expensive
 - Need high cost tooling and long development time
- Spring probes are expensive
 - Economic downturn accelerating need for cost reductions
 - Production factories need low cost replacement pins
- Spring probe delivery unpredictable
 - High cost means no inventory
 - Poor delivery lead time puts new product ramp at risk



Solution - SBT Contact

BGA Contact



SBT Contact is a stamped & etched contact with outside spring as well as inside leaf spring that provides a robust solution for Burn-in & test applications.

CHARACTERIZATION BURN-IN SLT ATE

Solution for 1.27 mm to 0.40 mm (LGA, BGA, QFP packages) in Burn-in & test applications.

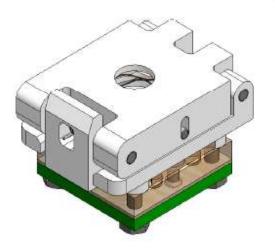
Contact technology has 3 part system. Top plunger, Bottom plunger and a spring. The BeCu plungers are stamped/etched and assembled to a stainless steel spring in automated system to enable reliable interconnect solution.

LGA Contact



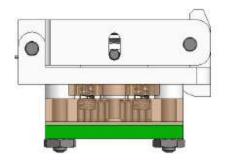
SBT Socket

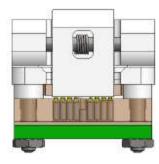


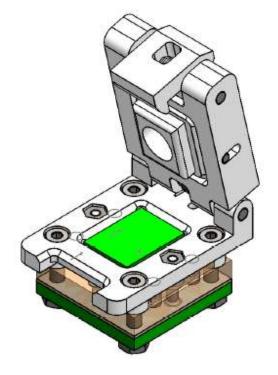


FEATURES:

- Wide temperature range (-55C to +180C)
 High current capability (up to 8A)
 Excellent signal integrity at high frequencies
 Low and stable contact resistance for reliable production yield
 Highly compliant to accommodate wide co-planarity variations
 Automated probe manufacturing enables low cost and short lead time

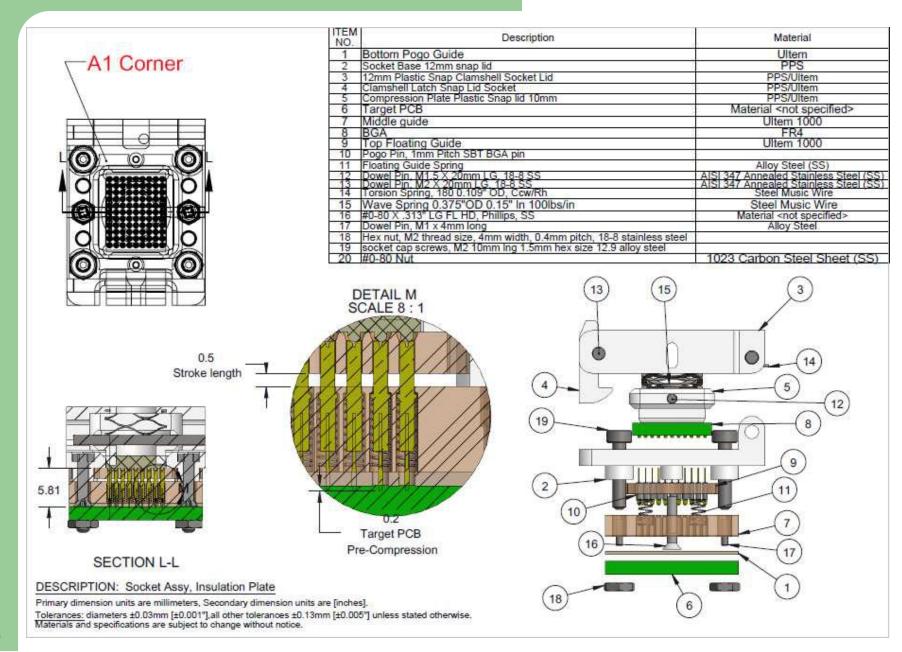






SBT Socket Details





SBT Contact

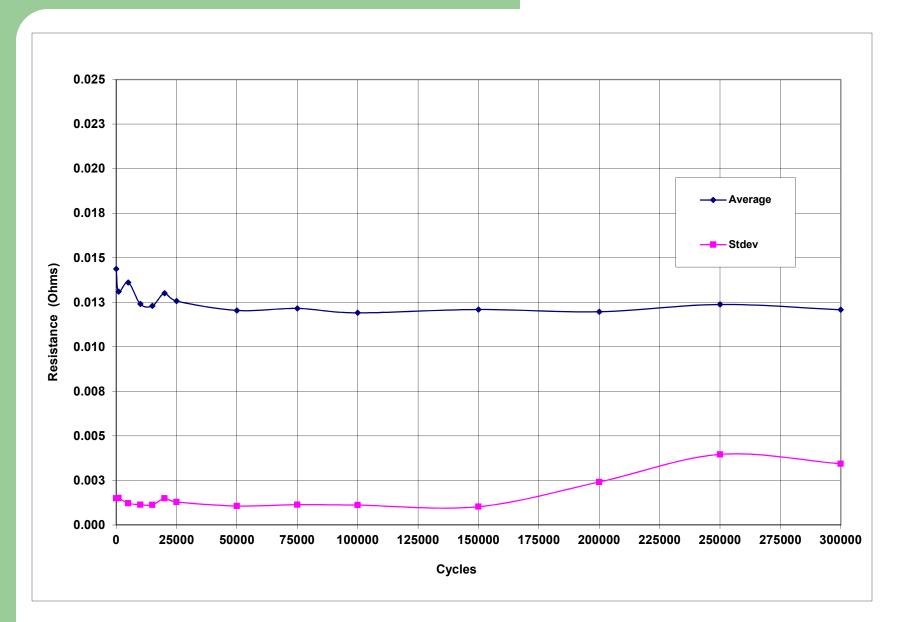


Typical Characteristics

- Contact resistance < 15 mOhms
- Self Inductance 0.88nH to 0.95nH
- Bandwidth 4.15GHz to 31.7GHz @-1dB
- Capacitance <0.3pF
- Force 18gm 34gm per contact
- Operating temperature -55 to +180° C
- Insertion/Extraction cycles >500,000*
- Current rating 4A to 8A per contact

Endurance Data – 1mm pin





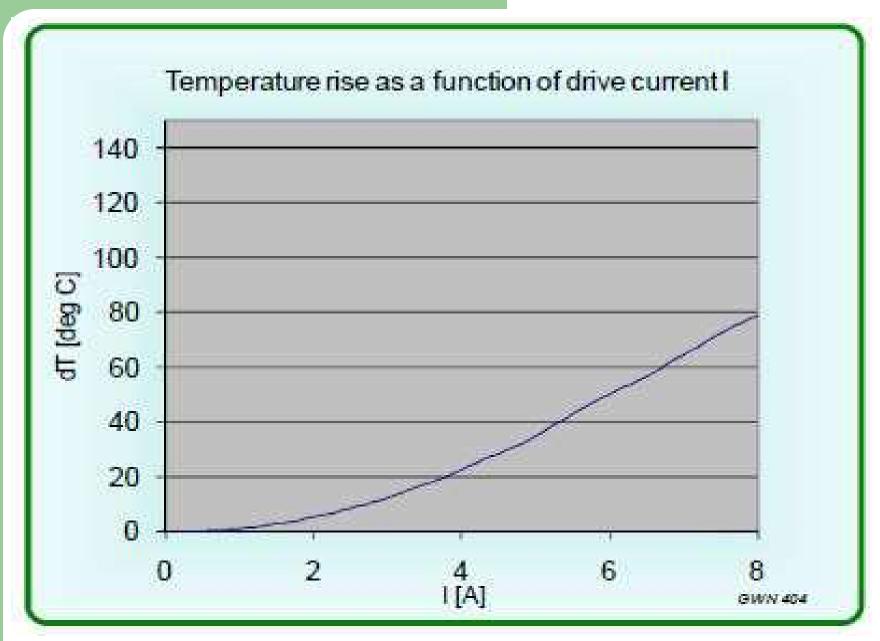
Force Deflection Resistance Data – 1mm pin





Current Data – 1mm pin





Bandwidth Data – 0.4mm pin

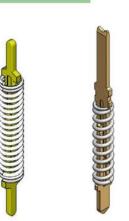


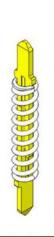
	Corner	Edge	Field	
Delay	15.4	14.4	14.6	ps
Risetime open	34.5	31.5	46.5	ps
Risetime short	96	30	120	ps ps
Risetime thru, 50Ω	33	30	33	
Insertion loss (1dB)	20.5	26.7	31.7	GHz
Insertion loss (3dB)	27.1	35.5	35.5	GHz
VSWR (2:1)	25.3	31.5	31.5	GHz

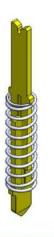
Pin Datasheet

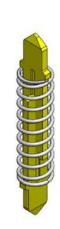












Pin Family	SBT						
Part Number	P-P204A	P-P185A	P-P184A	P-P196A	P-P150A	P-P151A	P-P152A
Minimum Pitch (mm)	0.35	0.4	0.4	0.5	0.5	1.0	1.0
Pin Type	BGA	BGA	LGA	BGA	LGA	BGA	LGA
Length (mm)	3.46	3.81	2.9	3.86	2.95	5.69	4.45
DUT Side Tip Shape	Crown	V Shape	Radius Cone	V Shape	Radius Cone	Notched V	Radius Cone
DUT Side Tip Dimension (mm)	0.17	0.14	0.12	0.2	0.06	0.54	0.1
PCB Side Tip Shape	Radius Cone						
PCB Side Tip Dimension (mm)	0.12	0.12	0.12	0.04	0.06	0.1	0.1
DUT Side Travel (mm)	0.3	0.5	0.3	0.33	0.33	0.6	0.6
PCB Side Travel (mm)	0.1	0.1	0.1	0.1	0.1	0.1	0.1
Force (g)	8.7	17	14.5	30	30	19	19
Cres (mOhms)	< 70	< 50	< 50	< 30	< 30	< 15	< 15
CCC @ ambient (Amps)	1	1.8	1.8	4.0	6.0	8.0	8.0
Bandwidth (GHz @ -1dB)**	23.5 - 26.1	20.5 - 31.7	20.5 - 31.7	5.2 - 15.7	5.2 - 15.7	14.1 - 21.9	14.1 - 21.9
Self inductance (nH)	0.92	0.98	0.98	0.88	0.88	0.93	0.93
Temperature (deg C)	-55 to +180C						
Insertion Cycles	50K	50K	50K	500K	500K	500K	500K

^{* 0.4}mm/0.5mm pitch SBT pins are used in 0.65mm and 0.8mm pitch applications

^{**} Bandwidth range is based on pin location (corner, edge, field). See report for test conditions and setup.

SBT Value Proposition



- Low cost pin solution 1/3rd of conventional spring probe cost
- Extreme temperature solutions (-55 to +180C)
- High power applications (excellent current rating of 4A to 8A @80C rise)
- High speed digital and RF applications (excellent bandwidth 4.15GHz – 31.7GHz)
- Less maintenance and handler downtime (longer cycle life 500K+)
- Reliable yield data due to stable contact resistance throughout life cycle
- High compliancy for large package warpage
- Stocked inventory due to high volume automated assembly

SBT Value Proposition



- SBT contact replaces spring pin in all lab and evaluation applications due to low cost and better electrical/mechanical performance than conventional pogo pin.
- Custom burn-in socket can be produced using SBT contact in 3 weeks when standard socket is not available.
- SBT sockets with wide temperature range are available in same footprint as elastomer GHz sockets.
- SBT sockets are robust and can be used in demonstration products for multiple handling process without contact degradation.